

MBAL-0104SM

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The MBAL-0104SM is a GaAs passive MMIC balun in a 4mm QFN surface mount package. It features excellent amplitude and phase balance across its 1 to 4 GHz frequency range that offers a 1:2 impedance ratio. The 4mm QFN package is a lead free, RoHS compliant package compatible with standard leaded and lead-free solder reflows. SMA connectorized evaluation packages are available. The MBAL-0104SM is an excellent choice for balanced amplifiers, clock distribution, and higher order Nyquist sampling in analog to digital converters.



Features

- 1 GHz to 4 GHz 1:2 Balun (Balanced to Unbalanced Transformer)
- Transforms 50 Ω Input to 100 Ω Differential (50 Ohm Single) Output
- Tuned for Optimal Phase/Amplitude Balance
- Applications: Analog to Digital Converters, Balanced Receivers, Baseband Digital Modulation, Signal Integrity
- RoHS Compliant
- MBAL-0104SM.S2P

Electrical Specifications - Specifications guaranteed for $+25^{\circ}$ C, measured in a 50Ω system.

Parameter	Frequency Range	Min	Тур	Max
Nominal Insertion Loss (dB)			3	
Nominal Phase Shift (Degrees)			180	
Amplitude Balance (dB)			±0	±0.5
Phase Balance (Degrees)			±2	±5
Common Mode Rejection (dB)	1 GHz to 4 GHz	25	33	
Excess Insertion Loss (dB) ¹⁻²			2.5	5
Isolation (dB)			8	
Output VSWR			3.6	
Common Port VSWR			1.25	

 $^{^{1}}$ Excess Insertion Loss = (Common Port to Output Port Insertion Loss) – 3dB.

Part Number Options

Model Number	Description	
MBAL-0104SM ¹	1 GHz to 4 GHz MMIC Balun, Surface Mount	
EVAL-MBAL-0104	Connectorized Evaluation Module	

Note: For port locations and I/O designations, refer to the drawings on page 2 of this document.

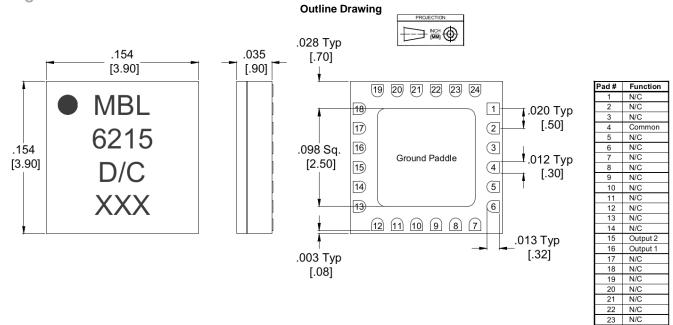
²Includes fixture losses.



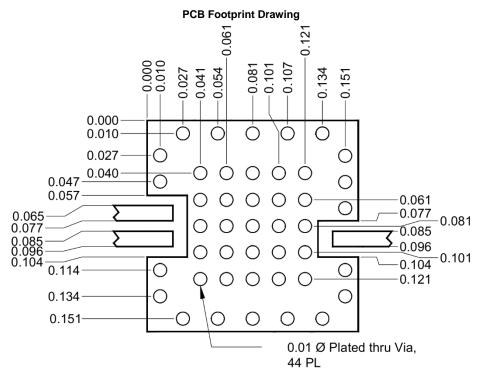
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24 N/C

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- 1. Substrate material is Ceramic.
- 2. I/O Leads and Ground Paddle are 1.4±0.6 microns (55±24 micro-inches) Au over 1.3 microns (51 micro-inches) Ni.
- 3. All unconnected pads should be connected to PCB RF ground.



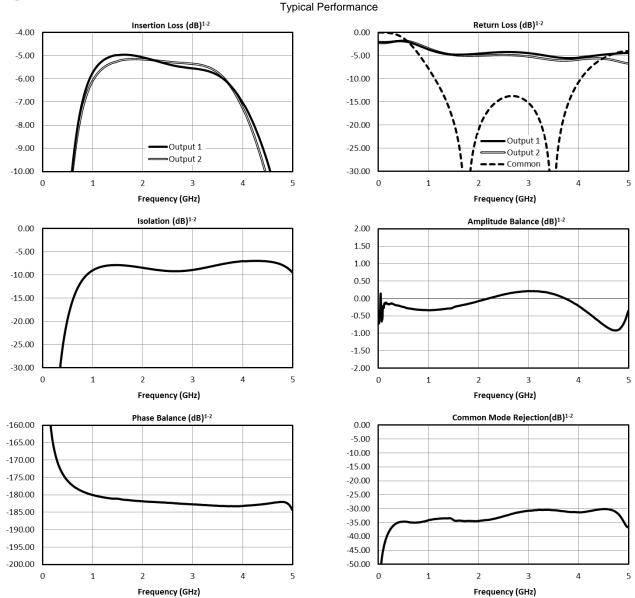
QFN-Package Surface-Mount Landing Pattern Click here for a DXF of the above layout.

Click here for leaded solder reflow. Click here for lead-free solder reflow.



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Pin Number	Function	Description	DC Interface Schematic
1-3, 5-14, 17-24	Non-connect (NC)	These pins are not connected internally. Datasheet performance is tested with NC pins grounded.	
4	Common	Pin 4 is DC open and AC matched to 50 Ω from 1 to 4 GHz. Blocking capacitor is optional.	Pin 4
15	Out 2	Pin 15 is DC short. Blocking capacitor is optional.	Pin 15 [∞]
16	Out 1	Pin 16 is DC short. Blocking capacitor is optional.	Pin 16 [∞]
Paddle	Ground (GND)	Ground pad should be connected to RF/DC ground with low electrical and thermal resistance.	

Absolute Maximum Ratings				
Parameter	Maximum Rating			
Output Port 1 DC Current	N/A			
Output Port 2 DC Current	N/A			
Common Port DC Current	N/A			
RF Power Handling	+30 dBm			
Operating Temperature	-65°C to +125°C			
Storage Temperature	-65°C to +125°C			

DATA SHEET NOTES:

- 1. Balun measured as a splitter. Combiner measurement is equivalent to splitter measurement.
- 2. Specifications are subject to change without notice. Contact Marki Microwave for the most recent specifications and data sheets.
- 3. Catalog circuits are continually improved. Configuration control requires custom model numbers and specifications

Note: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

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